



20V N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C (t<10s)		
20V	$4.6 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	24.1A		
200	$8.7 \text{m}\Omega$ @ $V_{GS} = 2.5 \text{V}$	17.5A		

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

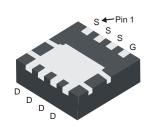
Features and Benefits

- Low R_{DS(ON)} ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- 100% UIS & Rg tested
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.072 grams (Approximate)

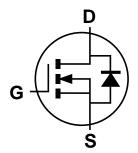
POWERDI3333-8



Bottom View



Top View



Equivalent Circuit

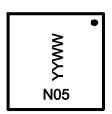
Ordering Information (Note 4)

Part Number	Case	Packaging	
DMN2005UFG-7	POWERDI3333-8	2,000/Tape & Reel	
DMN2005UFG-13	POWERDI3333-8	3,000/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



N05= Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 13 = 2013) WW = Week Code (01 ~ 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V_{DSS}	20	V		
Gate-Source Voltage	V_{GSS}	±12	V		
Continuous Drain Current (Note 6) V 4 EV	Steady State	$T_C = +25$ °C $T_C = +70$ °C	ID	18.1 14.5	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	24.1 19.3	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	58.3	Α		
Maximum Continuous Body Diode Forward Current	Is	2.6	Α		
Avalanche Current , L = 0.2mH			I _{AS}	23.9	Α
Repetitive Avalanche Energy, L = 0.2mH	E _{AS}	58.4	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5) $T_A = +25$ °C		P_{D}	1.05	W
Thermal Desistance, Junction to Ambient (Note 5)	Steady state	-	120	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ hetaJA}$	67	
Total Power Dissipation (Note 6) T _A = +25°C		P _D	2.27	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	Б	55	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ hetaJA}$	31	
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	6.1		
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C	

Notes:

^{5.} Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

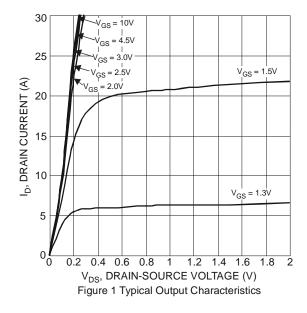


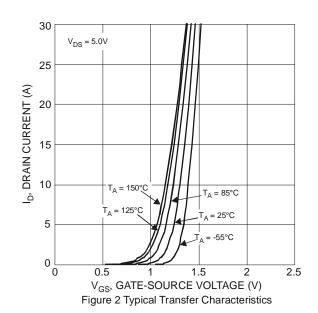
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	٧	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C		_	_	10	μΑ	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(th)}$	0.4	0.7	1.2	٧	$V_{DS} = V_{GS}, I_D = 250\mu A$	
Static Drain-Source On-Resistance	D		4	4.6	mΩ	$V_{GS} = 4.5V, I_D = 13.5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		4.9	8.7	11122	V _{GS} = 2.5V, I _D = 13.5A	
Diode Forward Voltage	V_{SD}	_	0.8	1.1	V	$V_{GS} = 0V, I_{S} = 27A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}		6,495		pF	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		546	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	477	_	pF		
Gate Resistance	Rg	_	0.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	68.8	_	nC	V _{DS} = 16V, I _D = 27A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	164	_	nC		
Gate-Source Charge	Q_{gs}	_	10.4	_	nC		
Gate-Drain Charge	Q_{gd}	_	17.4	_	nC		
Turn-On Delay Time	t _{D(on)}	_	12.4	_	ns	$V_{GS} = 5V$, $V_{DS} = 10V$, $R_{G} = 4.7\Omega$, $I_{D} = 13.5A$	
Turn-On Rise Time	t _r		25.7	_	ns		
Turn-Off Delay Time	t _{D(off)}		114	_	ns		
Turn-Off Fall Time	t _f		38	_	ns		
Body Diode Reverse Recovery Time	t _{rr}		16.1	_	ns	I _F = 13.5A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{rr}	ı	8.5	_	nC	$I_F = 13.5A$, $di/dt = 100A/\mu s$	

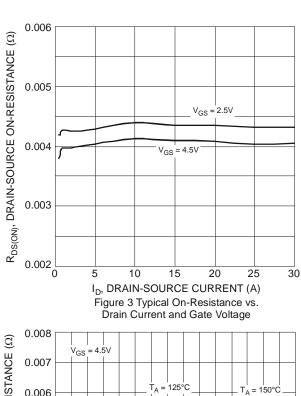
Notes:

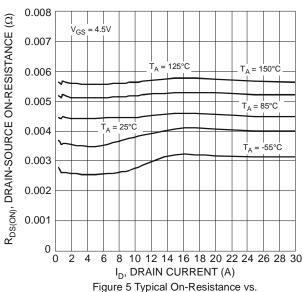
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

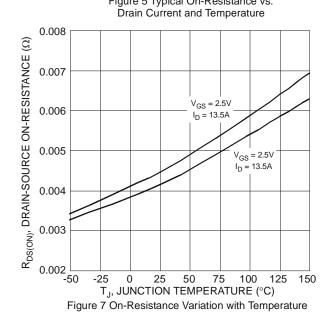


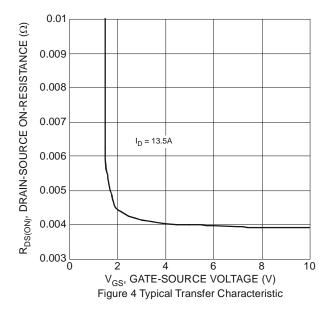












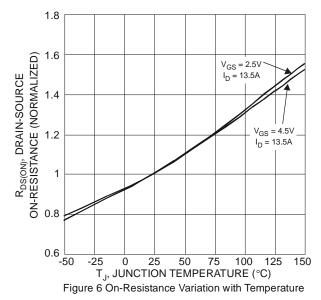
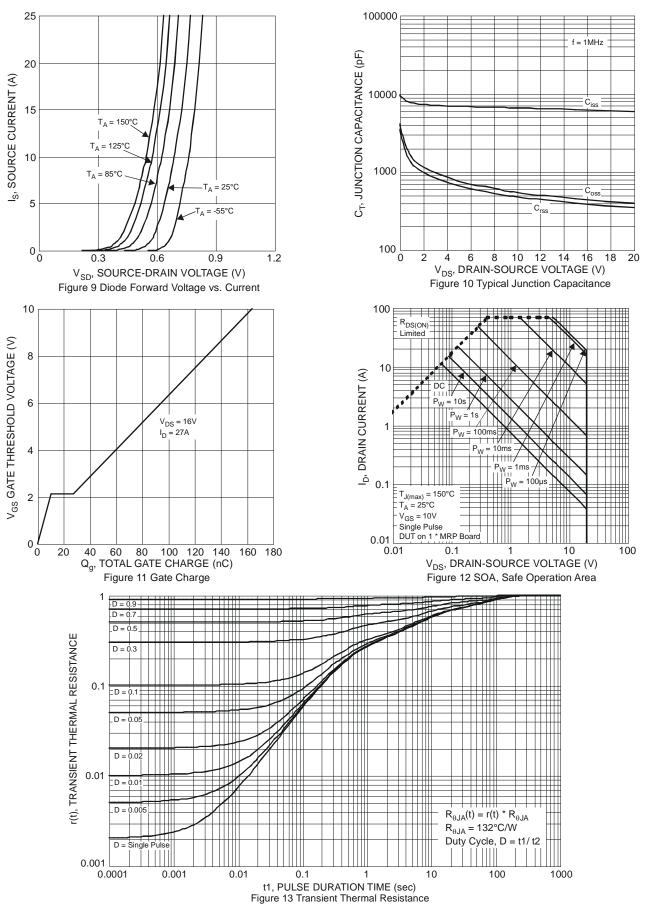


Figure 8 Gate Threshold Variation vs. Ambient Temperature

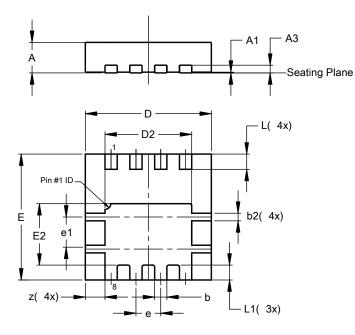






Package Outline Dimensions

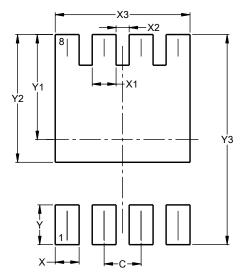
Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.



POWERDI®3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	-	-	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
е	_	_	0.65		
e1	0.79	0.89	0.84		
L	0.35	0.45	0.40		
L1	_	_	0.39		
z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	0.650			
Х	0.420			
X1	0.420			
X2	0.230			
Х3	2.370			
Y	0.700			
Y1	1.850			
Y2	2.250			
Y3	3.700			



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